

## Surface-Mount Glass Passivated Rectifier


**SMC (DO-214AB)**

Cathode Anode

### FEATURES

- Low profile package
- Ideal for automated placement
- Glass passivated pellet chip junction
- Low forward voltage drop
- Low leakage current
- High forward surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)


**RoHS**  
COMPLIANT

### LINKS TO ADDITIONAL RESOURCES



3D Models

### TYPICAL APPLICATIONS

For use in general purpose rectification of power supplies, inverters, converters, and freewheeling diodes for consumer, and telecommunication.

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	8.0 A
$V_{RRM}$	400 V, 600 V, 800 V, 1000 V
$I_{FSM}$	200 A
$I_R$	10 $\mu$ A
$V_F$ at $I_F = 8$ A ( $T_J = 125$ °C)	0.87 V
$T_J$ max.	150 °C
Package	SMC (DO-214AB)
Circuit configuration	Single

### MECHANICAL DATA

**Case:** SMC (DO-214AB)

Molding compound meets UL 94 V-0 flammability rating  
Base P/N-E3 - RoHS-compliant , commercial grade

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3 suffix meets JESD 201 class 2 whisker test

**Polarity:** color band denotes cathode end

MAXIMUM RATINGS ( $T_A = 25$ °C unless otherwise noted)						
PARAMETER	SYMBOL	S8GS	S8JS	S8KS	S8MS	UNIT
Device marking code		S8GS	S8JS	S8KS	S8MS	
Maximum repetitive peak reverse voltage	$V_{RRM}$	400	600	800	1000	V
Maximum RMS voltage	$V_{RMS}$	280	420	560	700	V
Maximum DC blocking voltage	$V_{DC}$	400	600	800	1000	V
Maximum average forward rectified current	$I_{F(AV)}$ <sup>(1)</sup>	8.0				A
	$I_{F(AV)}$ <sup>(2)</sup>	1.6				A
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	$I_{FSM}$	200				A
Peak forward surge current single half sine-wave at 1.0 ms	$I_{FSM}$	450				A
Operating junction and storage temperature range	$T_J, T_{STG}$	-55 to +150				°C

### Notes

- (1) Mounted on aluminum PCB 30 mm x 30 mm with aluminum heatsink
- (2) Free air, mounted on recommended copper pad area



<b>ELECTRICAL CHARACTERISTICS</b> ( $T_J = 25\text{ }^\circ\text{C}$ unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	$I_F = 4.0\text{ A}$	$T_J = 25\text{ }^\circ\text{C}$	$V_F^{(1)}$	0.90	-	V
	$I_F = 8.0\text{ A}$			0.97	0.985	
	$I_F = 4.0\text{ A}$	$T_J = 125\text{ }^\circ\text{C}$		0.80	-	
	$I_F = 8.0\text{ A}$			0.87	0.971	
Reverse current	Rated $V_R$	$T_J = 25\text{ }^\circ\text{C}$	$I_R^{(2)}$	-	10	$\mu\text{A}$
		$T_J = 125\text{ }^\circ\text{C}$		-	180	
Typical reverse recovery time	$I_F = 0.5\text{ A}, I_R = 1.0\text{ A}, I_{rr} = 0.25\text{ A}$		$t_{rr}$	3.4	-	$\mu\text{s}$
Typical junction capacitance	4.0 V, 1 MHz		$C_J$	63	-	pF

**Notes**

- (1) Pulse test: 300  $\mu\text{s}$  pulse width; 1 % duty cycle
- (2) Pulse test: pulse width  $\leq 40\text{ ms}$

<b>THERMAL CHARACTERISTICS</b> ( $T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)						
PARAMETER	SYMBOL	S8GS	S8JS	S8KS	S8MS	UNIT
Typical thermal resistance	$R_{\theta JA}^{(1)(2)}$	88				$^\circ\text{C/W}$
	$R_{\theta JM}^{(3)}$	4.5				

**Notes**

- (1) The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/R_{\theta JA}$
- (2) Thermal resistance junction-to-ambient to follow JEDEC<sup>®</sup> 51-2A, device mounted on FR4 PCB, 2 oz., standard footprint
- (3) Thermal resistance junction-to-mount to follow JEDEC<sup>®</sup> 51-14 transient dual interface test method (TDIM)

<b>ORDERING INFORMATION</b> (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
S8JS-E3/I	0.243	I	3500	13" diameter plastic tape and reel

**RATINGS AND CHARACTERISTICS CURVES** ( $T_A = 25\text{ }^\circ\text{C}$  unless otherwise noted)

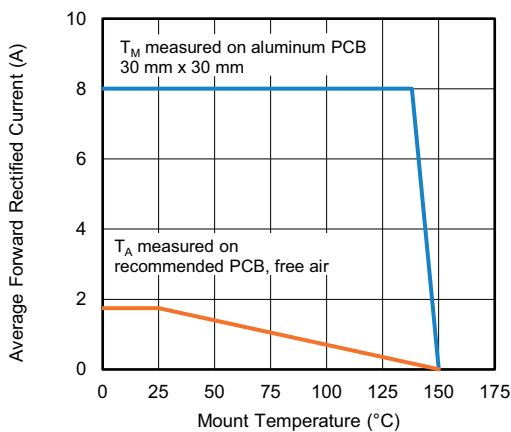


Fig. 1 - Forward Current Derating Curve

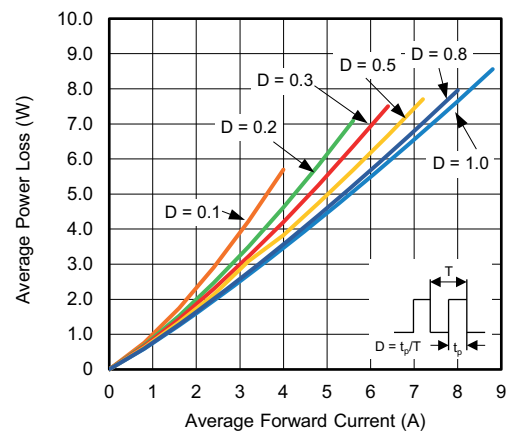


Fig. 2 - Average Power Loss Characteristics

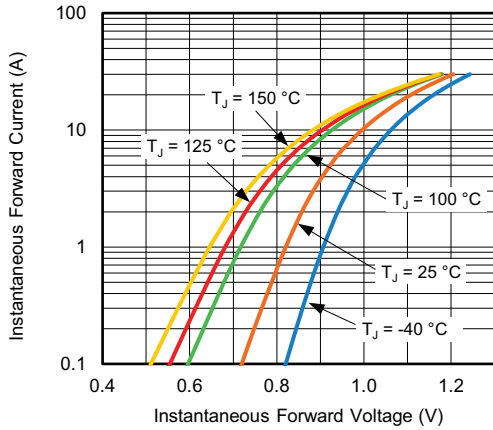


Fig. 3 - Typical Instantaneous Forward Characteristics

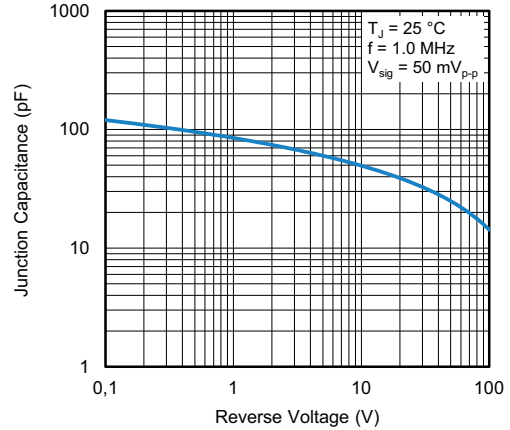


Fig. 5 - Typical Junction Capacitance

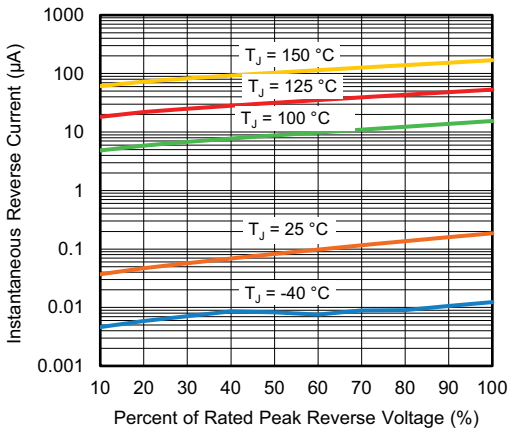


Fig. 4 - Typical Reverse Characteristics

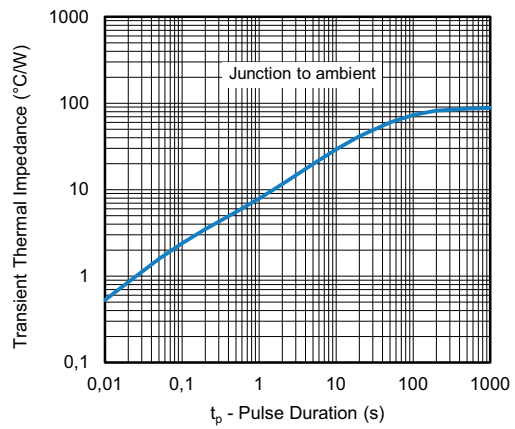
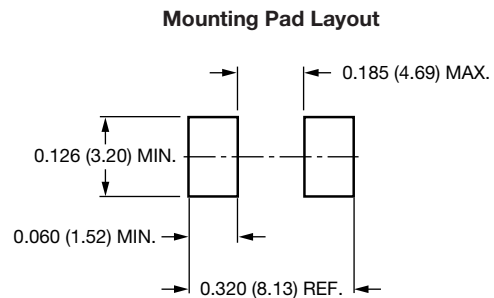
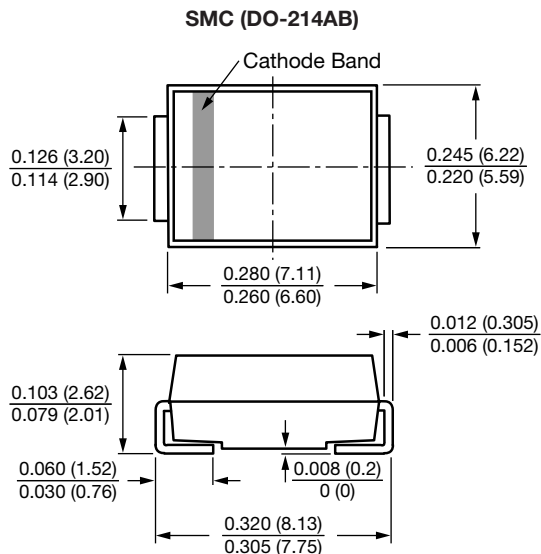


Fig. 6 - Transient Thermal Impedance

**PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)





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